國立金門大學 電機工程學系學士班 課程規劃表

本學系學生畢業時至少應修滿 132學分,包括

National Quemoy University Department of Electrical Engineeringl Bachelor's Program Program Curriculum Plan

112學年度入學新生適用 Applicable for students Admitted in Academic Year 2023

修訂歷程

		Graduation Requiren 共同必修 <u>8</u> 學分 General Core Curricu	nent: A	A min	imum			urses:	16 c	credits					Appr	Revision H 112年03月22日11 oved on March 22, 2023, during the 1st Departmental-	istory 1學年度第 level Curric	二學期第一 iculum Plann 2nd S	ing Commit emester, Ac	ittee Meeting of cademic Year
		院 必 修 <u>6</u> 學分 College Required Co	urses:	6 cre	edits	可避	修非本學系所開設之課	系。 Depa	必 亻	修 <u>58</u> 學	分 ired Courses: 58 credits					112年04月12日11 pproved on April 12, 2023, during the 1st college-leve 112年6月07日11 I on June 7, 2023, during the 1st school-level Curriculu	l Curriculur 1學年度第 ım Planning	m Planning (S 二學期第二 g Committee	Committee I emester, Ac 次校級課程 Meeting of Ac	Meeting of the cademic Year 程規劃委員會 of the 2nd Sem
			s: 44 d			udin	修非本學系所開設之課 g up to 12 credits from ot 二年級			tments) 下學期	三年級	上点	學期	下學		112年10月17日11: red on October 17, 2023, during the 1st Departmental- 四年級	2學年度第- level Curric - 學 期	iculum Plann	次系級課程	程規劃委員會
		First Year 通識 General Education	Sem 學分 Cr	時數 Hr	Seme 學分 Cr	ester 時數 Hr	Second Year	Semes 學分 Cr	ter 寺數 Hr	Semester 學分 時數 Cr Hr	Third Year	Sem 學分 Cr	ester 時數 Hr	Seme 學分 Cr	ster 時數 Hr	Fourth Year Se 學:	mester 分 時妻		ester	
		體育 Physical Education 國文(一)			曹育課和	呈實施	·辦法」規定。Follow the uni	iversity	's "Pl	hysical Edu	cation Curriculum Guidelines	s" – 0 c	redit							0
共同必修 General Required Courses		Chinese I 英文(一) English I	2 2	2 2																
		服務教育 Service Education 國文(二)	0	1	2	2														8
		Chinese II 英文(二) English II			2	2														
	*修總計	服務教育 Service Education			0	1														24
Suc	ototal 院必修 College	微積分(一) Calculus I 計算機概論	3	3																-
	Courses 院必修總計 Subtotal	可 升 傚 杌 姗 Introduction to computer science	3	3	_					_		_		_						
		普通物理實驗(一)	1	3	0		電子電路實習(一) Microelectronic Circuits	1	3	0	電子學(三) Microelectronic Circuits III	3	3	0		■ 0 專題製作(三) 2		0		6
	条必修 Department Required Courses	Physics Experiments I 普通物理學(一) Physics I	3	3			Experiments I 電子學(一) Microelectronic Circuits I	3	3		通訊原理 Principles of	3	3			Senior Project III				
		數位邏輯 Digital logic 材料科學與工程導論(一)		3			電路學(一) Electronic circuits I 工程數學(一)		3		信號與系統 Signals and Systems 專題製作(一)	3	3							
		Introduction to Materials Science and Engineering I 微積分(二)	3	3	2	2	Engineering Mathematics I 電子電路實習(二)	3	3	1 2	Senior Project I 專題製作(二)	2	2							_
		Calculus II 普通物理學(二) Physics II			3		Microelectronic Circuits Experiments II 電子學(二) Microelectronic Circuits II			3 3	Senior Project II			2	2					_
		普通物理實驗(二) Physics Experiment II 程式設計			1	3	電路學(二) Electronic Circuits II 工程數學(二)			3 3										
		Program Design			3	3	Engineering Mathematics II 電磁學 Electromagnetics		***************************************	3 3								***************************************		
	系必修總計 Subtotal		10		10			10		13		11		2		2		0		58
	·修總計 ototal		16		10			10	AAAA	13		11		2		2		0		64
	共同選修 General Professional Electives	資訊科技認證(一) Information Technology Certification I 資訊科技認證(二)	2	2							科技新聞導讀 Science news reading	2	2			專題研究(一) Directed Research I	2			
		貝 がイヤス 恋語 (一) Information Technology Certification II			2	2					科技新聞翻譯 Science news translation 線性代數			2		工程倫理 Engineering Ethics 3 校外專業實習(一)				_
											Linear Algebra			3		を A C A C A C A C A C A C A C A C A C A	4	2	2	
																企業實務培訓 Enterprises Practical 校外專業實習 (二)		3	3	
		數位邏輯實習 Digital logic internship			3	3	工程模擬軟體 Engineering Simulation	3	3		數值分析 Numerical Analysis	3	3			Extramural Practicum II 數位影像處理 Digital Image Processing	3	3	4	
		數位系統設計			3		Software 物件導向程式設計 Object-Oriented	3	3		嵌入式系統概論 Introduction to Embeded	3	3			高等通訊系統模擬與實驗 Advanced Communication System Simulation and	3	3		_
		Digital System Design 機率與應用 Probability theory and			3	3	Programming 資料結構	3	3		System 機器人程式設計	3	3			Experiment 高等電力系統	3			
		applications					Data Structure 計算機結構		9	3 3	Robot Programming 人工智慧與機器學習 Artificial Intelligence and	3	3			Advanced Power System 深度學習概論 Introduction to Deep 3				_
							Computer Structure 機器人控制入門 Introduction to Robot			3 3	Machine Learning 雲端通信整合實務 Integration to Cyber Cloud	3	3			Learning 模糊系統	3			_
							Control 自動控制				and Heterogeneous Networks of Practices 電機機械(一)		-			Fuzzy System 自旋電子材料學				_
							Automatic Control			3 3	Electric Machinery I 5G應用服務與電信新技	3	3			Spintronics materials and devices 3	3			_
											術趨勢 The Application and Service of 5G and new technology tendency of	3	3			電力電子學 Power Electronics	3			
											telecommunication 數位信號處理概論			3		智慧淨零碳排與AI應用 Smart net-zero carbon	2			
											Introduction to Digital Signal Processing 數位通訊導論					emissions and AI applications 編碼理論	3			_
											Introduction to Digital Communications 通訊實驗			3		Coding Theorem 鎖相迴路設計與應用	3	3	3	_
											Communication Laboratory 傳輸系統電路設計與模擬 Circuit Design and			3		Design and Application for Phase Locked Loop 通訊網路積體電路設計 Communications Network		3	3	_
											Simulation for 物聯網應用系統 System and application of			3		Integrated Circuit Design 電力電子實務 Practice of Power		3	3	_
											internet of things 行動通信概論 Introduction to cellular			3		Electronic 智慧型計算 Intelligent Computation		3	3	
											telecommunication 電機機械(二) Electric Machinery II			3	3	深度學習 Deep Learning		3	3	_
				-							電力系統 power system 磁性科技與應用 Magnetic technology and		•	3		工業配電 Industrial Power		3	3	_
											applications			3	<u></u>					_
		材料科學與工程導論(二) Introduction to Materials Science and Engineering II			3	3	微處理器系統與實驗 Microprocessor Systems and Experiments	3	3		FPGA系統設計實務 FPGA System Design and Practice	3	3			薄膜工程 Thin Film Engineering	3			
	固態與積體 電路領域 Solid state and integrated circuit						單晶片原理應用 Pinciples and applications of single chip	3	3		超大型積體電路設計導論 Introduction to VLSI Design	3	3			射頻積體電路與模擬 Simulation and Design of Radio Frequency Integrated	3			
							microcomputer lab 固態分析技術 Solid-State Analysis Techniques			3 3	微波系統導論 RF Microwave Wireless	3	3			Circuits 模式化通訊IC設計 Model-based 3	3			-
							Techniques 硬體描述語言程式設計與 模擬 System Design Using		Managaman and an and an and an and an	3 3	看體電路模擬實務 Integrated Circuits Design	2	2			Communication IC Design 半導體製程技術	3			-
							Hardware Description Language		Annasa da		Practice					Semiconductor Technology 射頻無線系統與應用				
							電腦輔助電路設計 Computer-Aided Design		THE REAL PROPERTY OF THE PROPE	3 3	高速電路板設計 High-Speed PCB Design 用瞎性類比積電电路作局 設計			2	2	Rf Wireless Systems and Applications 3	3			_
									tandaanaanaanaanaanaanaa la,		Advanced Analog IC Layout Design and			3	3	超大型積體電路設計 VLSI Design		3	3	_
									THE REAL PROPERTY OF THE PROPE		感測器實務 Practice and Applications o Sensor	f		3	•	表面工程 Surface Engineering 大陽能技術		3	3	-
									AMARIA AM							太陽能技術 Technology of solar energy 高頻電路佈局與模擬 Layout and Simulation of		3	3	
									Anna anna anna anna anna anna anna anna							High Frequency Circuits 類比積體電路設計與模擬 Analog Integrated Circuits:		3	3	
																Design and Simulation 半導體元件及物理 Semiconductor Components		3	3	_
																and Physical				_
击 业	医修總計		2							18		34		40				48		222

[、]畢業總學分132學分,共同必修 24學分[含通識課程16學分(由通識中心規劃)],專業必修(含院必修及系必修)64學分,選修學分包含12學分可選修非本系所開設之課程,且須通過「本校學生英文及資訊能力畢業門檻及輔 The total number of credits for graduation is 132 credits, General Required Courses: 24 credits [including General Education: 16 credits(planned by general education)], Professional Required: 64 credits (including College Required and Department Required Courses), and there are 12 credits of elective courses that are not offered by this department, Students graduation requirements follow the university's "Graduation Threshold and Counseling Guidelines for English and Information

二、已修習通訊原理方可選修數位通訊導論、數位通訊系統、通訊實驗。已修習信號與系統方可選修數位信號處理概論。已修習微積分(一)方可修習微積分(二)。

Completion of the course on Principles of Communications is a prerequisite for taking Introduction to Digital Communications, Digital Communication Systems, and Communication Laboratory. Completion of the Signals and Systems is a prerequisite for taking Introduction to Digital Signal Processing. Calculus I is a prerequisite for Calculus II.

三、「專題製作(一)、(二)、(三)」得抵修「專業實習(一)、(二)、(三)」;專題研究(一)得抵修「專題製作(三)」。 "Senior Project I, II and III " can be offset by "Project Production I, II and III "; "Directed Research I can be offset by "Senior Project III". 四、學士班四年級課程與碩士班課程名稱相同時,課程同時適用碩士班。

When the course names in the fourth-year undergraduate curriculum match those in the master's program, the course is applicable to the master's program at the same time. 五、表列選修科目為預定科目,將視實際需要而調整。 Elective courses listed are tentative and may be adjusted according to actual circumstances.